

# *Point defect scattering in Si nanowires*

*Alessandro Pecchia*



**CNR - ISMN** *Institute for Nanostructured Materials*

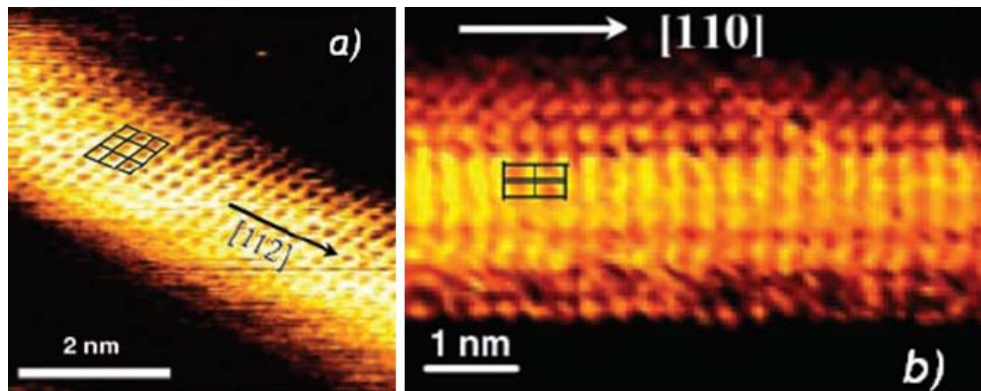


**University of Roma "Tor Vergata"**

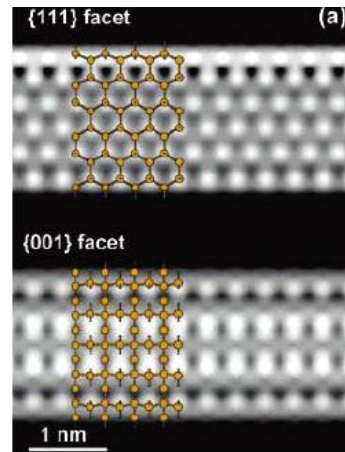
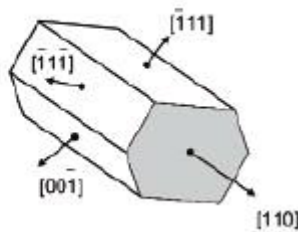
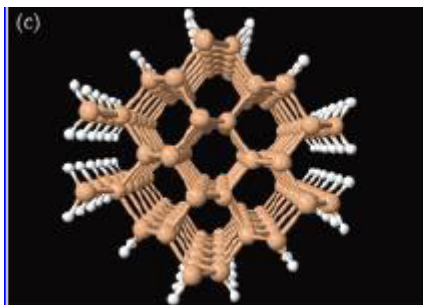
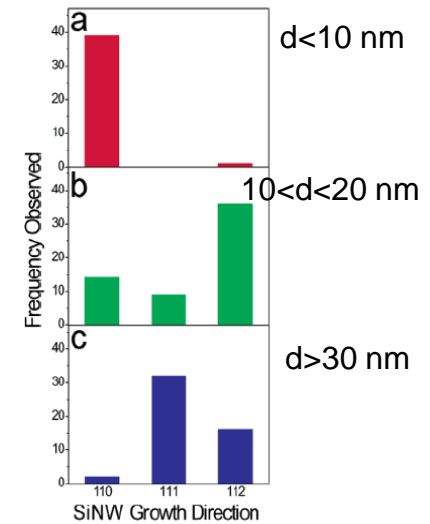
*A Gagliardi, G. Romano, G. Penazzi, M. Auf der Maur, M. Povolotskyi, F. Sacconi, Aldo Di Carlo*

- Introduction
- DFTB and extensions to NEGF
- Results of charged defect scattering in SiNW

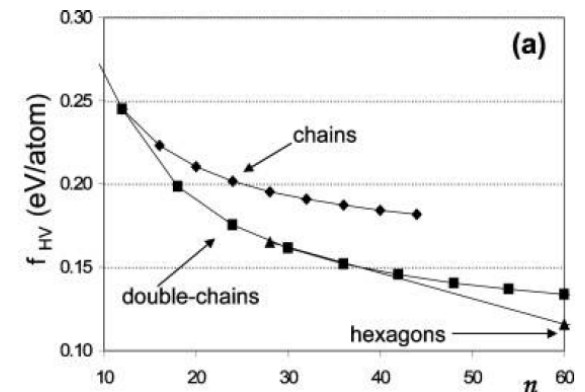
D. D. D. Ma. *et al.*, *Science*, vol. 299, pp. 1874-1877, 2003

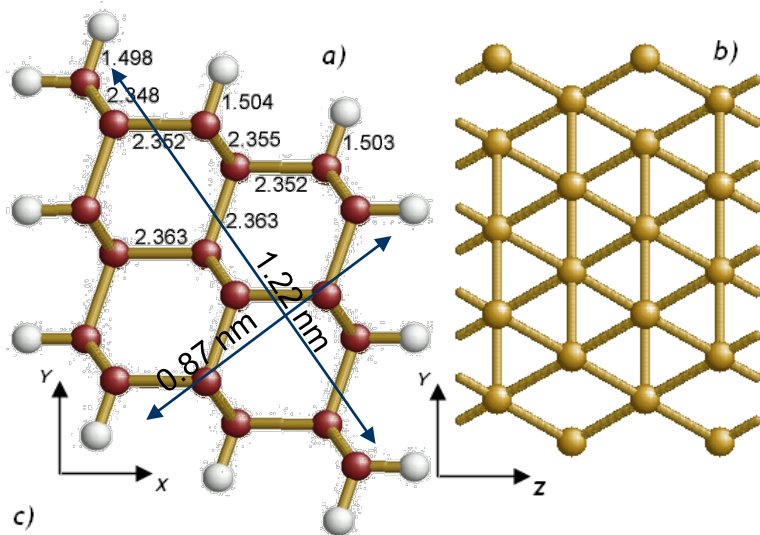


Low diameter (110) SiNW are energetically favoured  
 Show less sensitivity to disorder and size variations



Tzu-Liang Chan, *Nano Lett.*, Vol. 6, No. 2, 2006





We considered [110] oriented SiNW

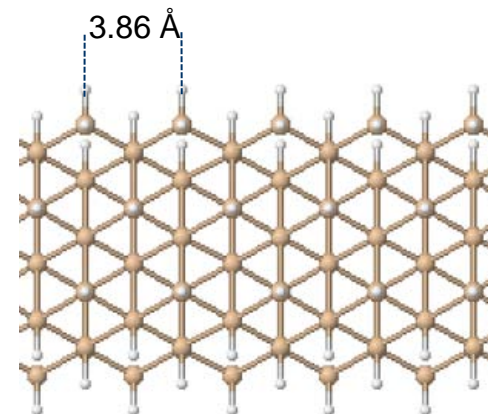
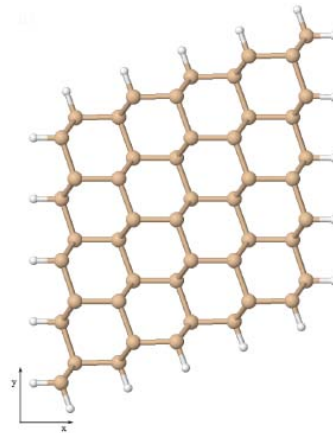
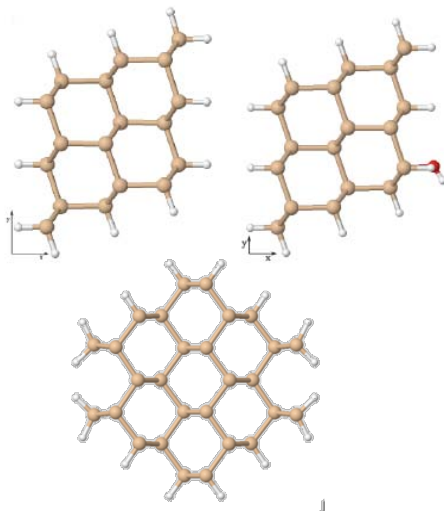
Total energy minimization has been performed with semi-empirical DFTB

The structures are H-passivated

Calculations on SiNW of 1.2-2.0 nm

1.2 nm

2.0 nm



DFTB = DFT based Tight-Binding method

**Kohn-Sham equation:**



$$\sum_{\nu} \left[ H_{\mu\nu}^0 + H_{\mu\nu}^{SCC} [\delta n] - E_k S_{\mu\nu} \right] c_{\nu}^k = 0$$

$$H_{\mu\nu} = \begin{cases} \varepsilon_{\mu} \\ \langle \mu | V [n_{\mu}^0 + n_{\nu}^0] | \nu \rangle \end{cases}$$

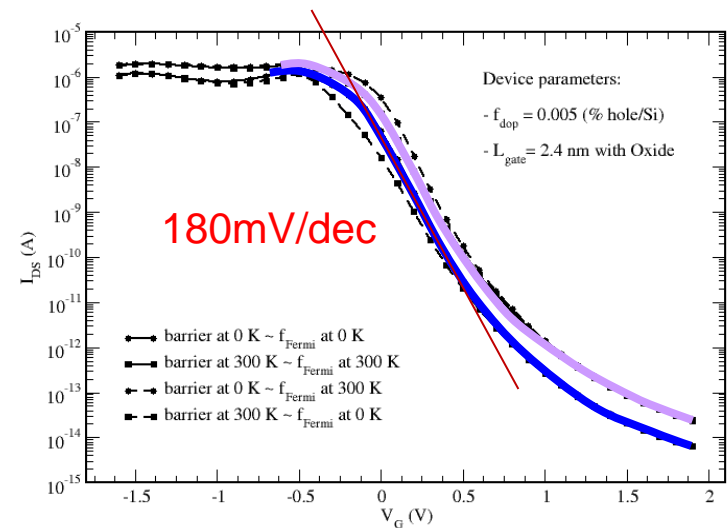
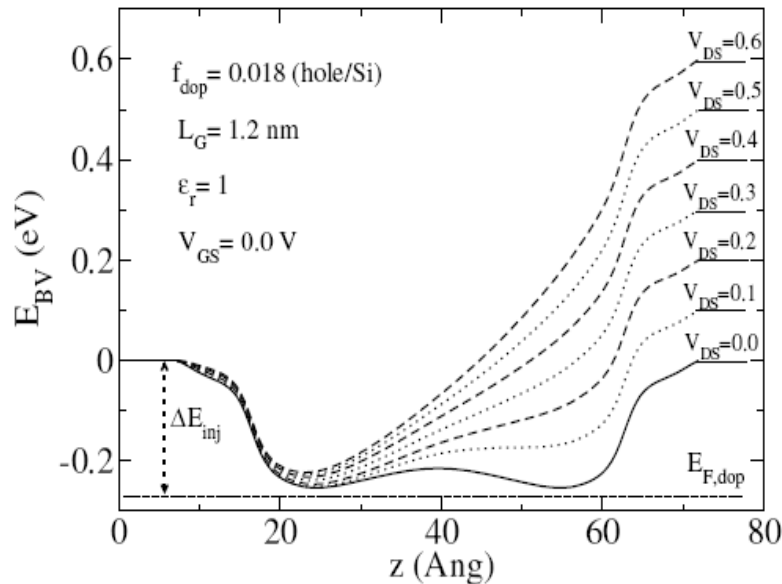
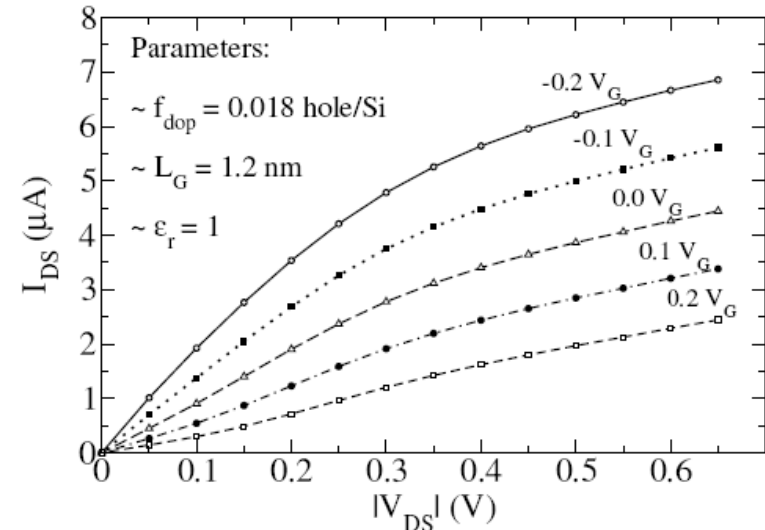
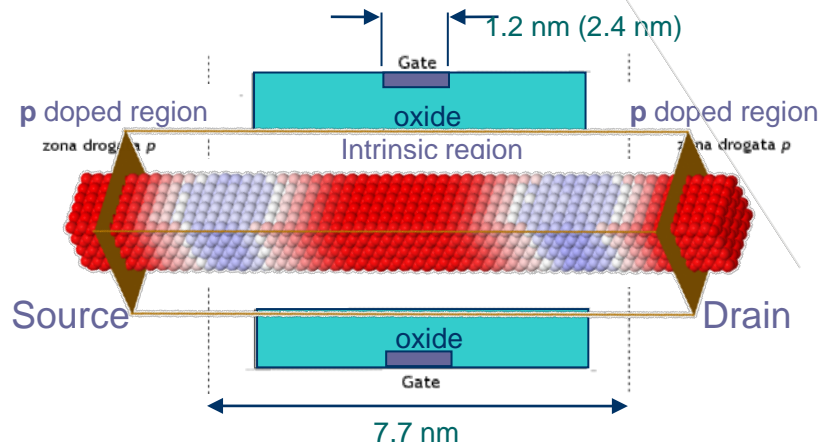
**onsite atomic energy levels**

**two-centre density superposition**

$$S_{\mu\nu} = \langle \mu | \nu \rangle$$

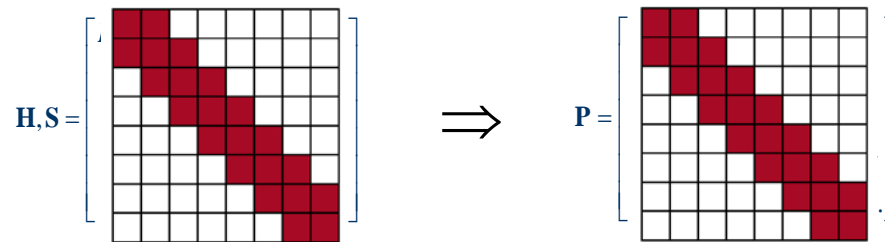
$$H_{\mu\nu}^{SCC} = \frac{1}{2} S_{\mu\nu} \sum_{\sigma} (\gamma_{\mu\sigma} + \gamma_{\nu\sigma}) \Delta q_{\sigma}$$

[Elstner, et al. Phys. Rev. B 58 (1998) 7260]

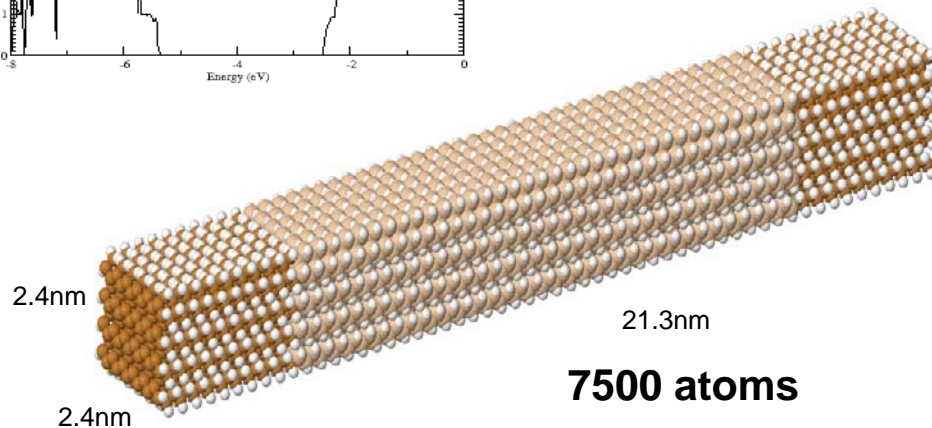
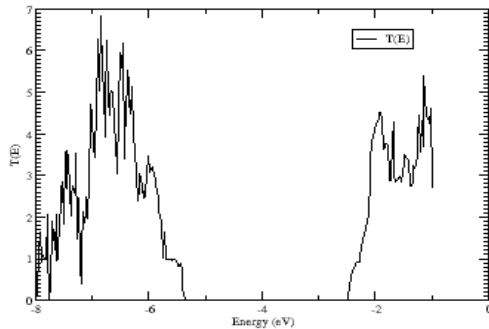


[Pecchia et al., IEEE trans. nanotechnol. (2007) ]

# Iterative scheme



$$q_{\mu} = \sum_{\nu} P_{\mu\nu} S_{\nu\mu}$$

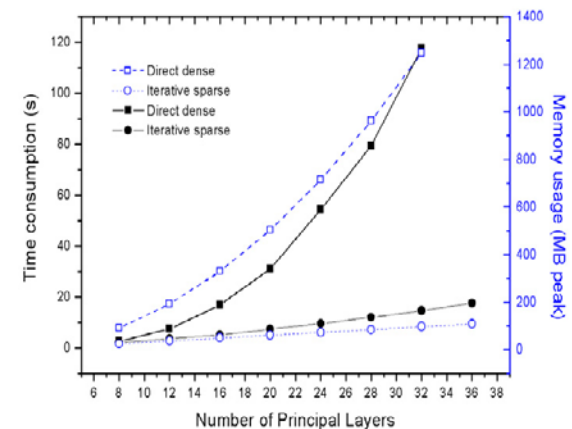


$O(N m^3)$

## PROFILING

Charge density and potential:	20 h
Density of States (350 points):	6 h
Peak memory:	876 MB

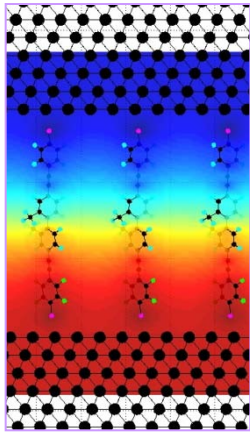
Calculations on single PC Linux core  
Intel(R) Core(TM)2 CPU 6600 @ 2.40GHz



[Penazzi, et al. New J. Phys. 10 (2008) ]



2-terminals

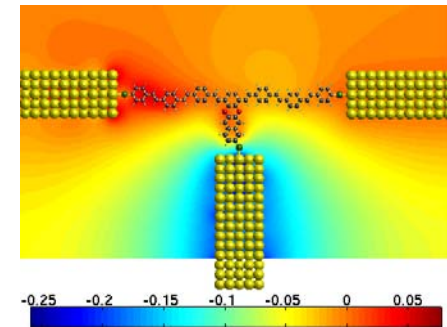


Discretize in real space

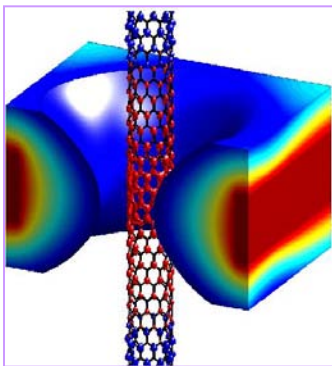
$$\Delta\rho(r) = \sum_{\mu} \Delta q_{\mu} n_{\mu}(r)$$

The Poisson equation is solved with a multi-grid algorithm (MUDPACK).

gated (3-term.)



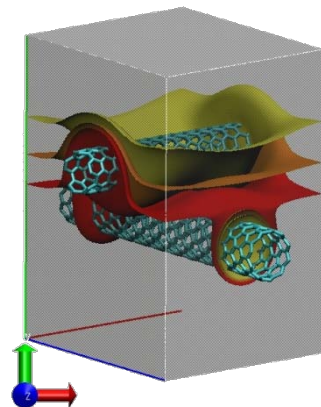
coaxially-gated



This allows to solve complex boundary conditions (bias, gate)

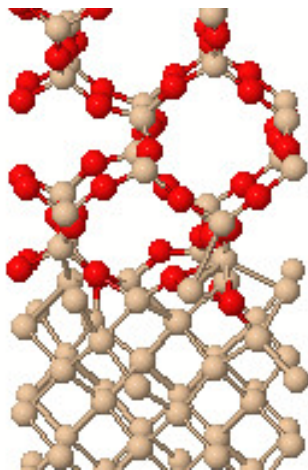
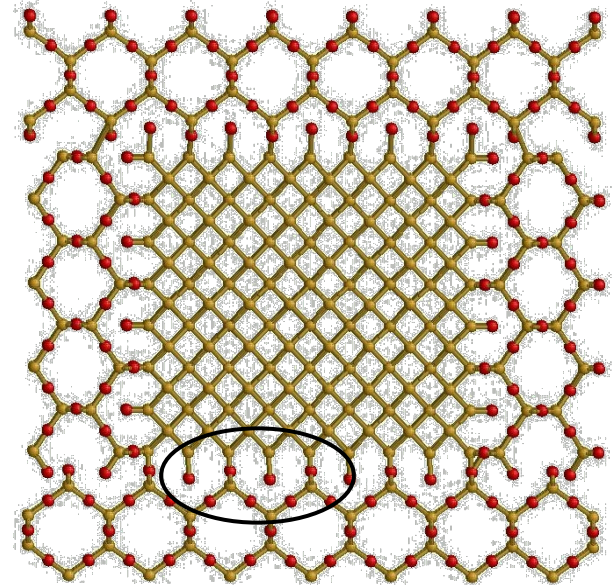
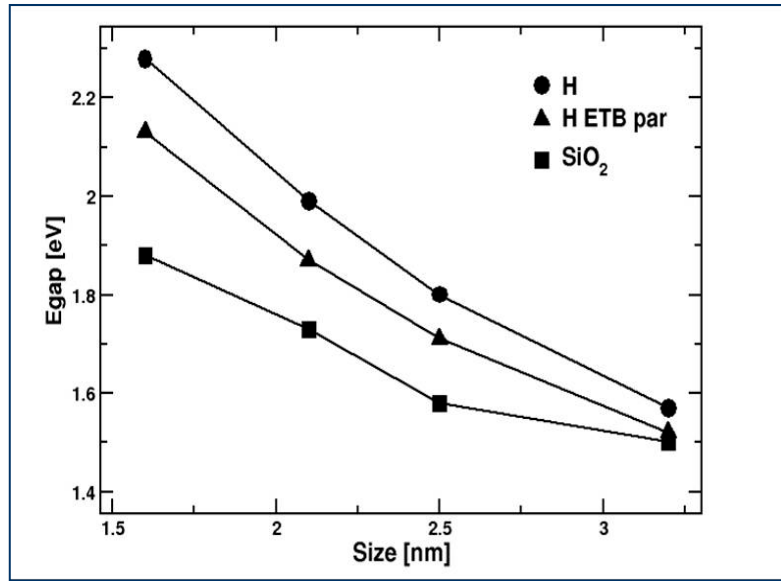
$$\nabla^2 V = -4\pi\Delta\rho$$

4-terminals





# Bandgap vs passivation



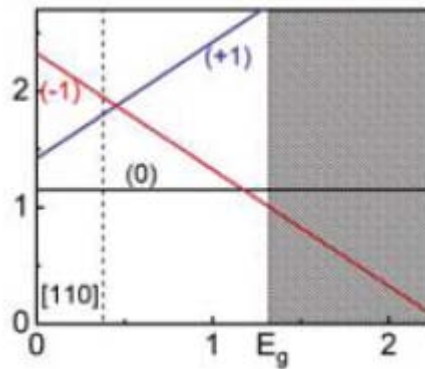
**DFTB** can be used to relax medium-sized structures/interfaces

**Challenge:** realistic oxide around a NW (defect).

Ki-Ha Hong et al., *Nano Lett.* 2010, 10, 1671-1676

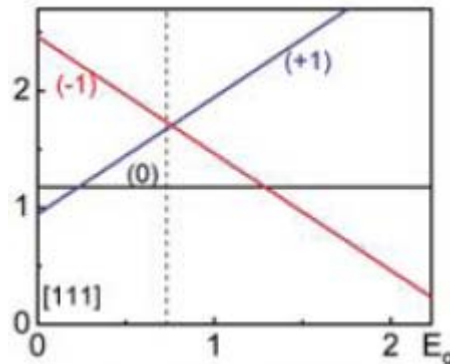
Phase stability diagrams of charged db defects

$$E_F^q = E_{SDB}^q - E_{SiNS}^0 + \mu_H + q(\varepsilon_{VBM} + \varepsilon_F)$$



SiNW [110]

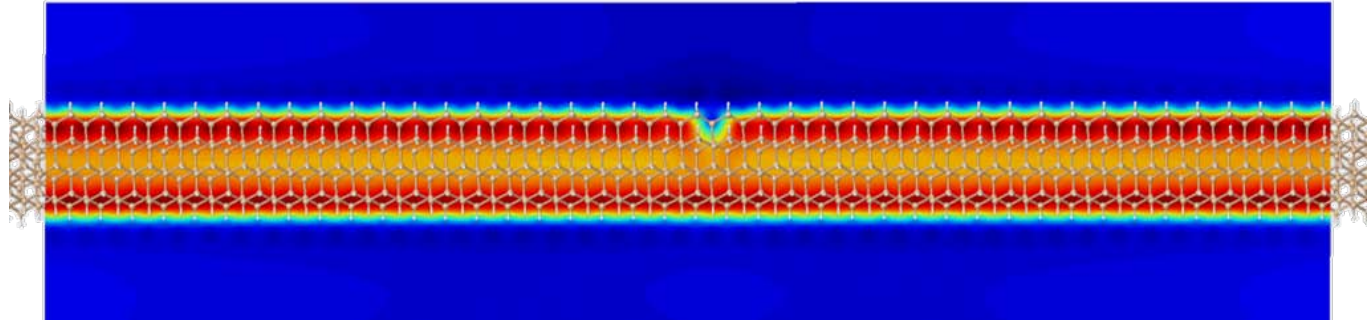
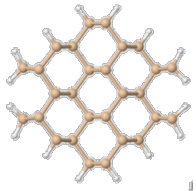
- can have negatively charged surface DB
- for Fermi Energy close to the CB.
- no positively charged DB.



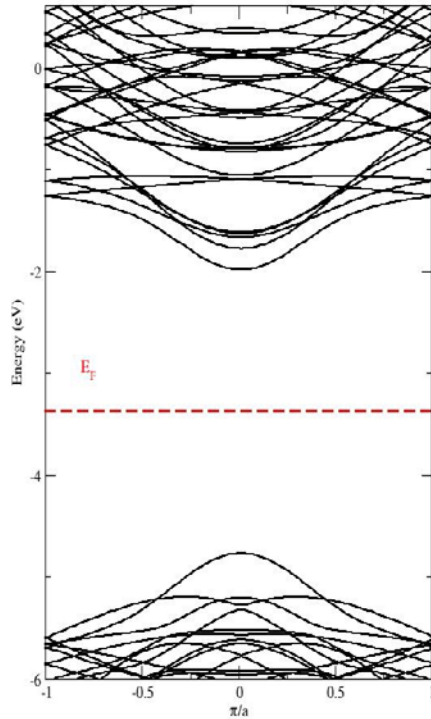
SiNW [111]

- can have negatively and positively charged DB

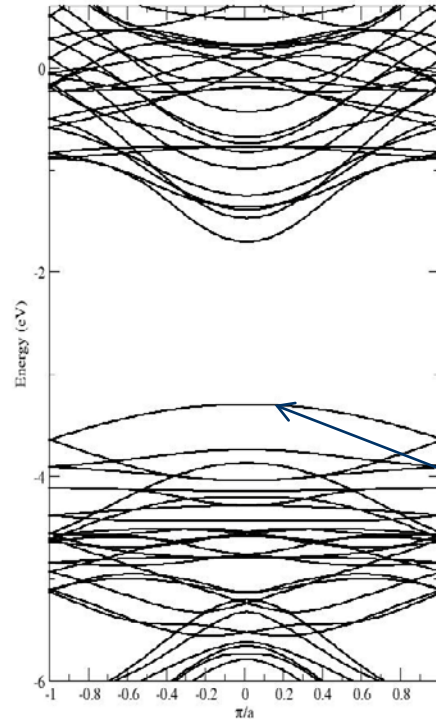
# Bandstructures and DB states



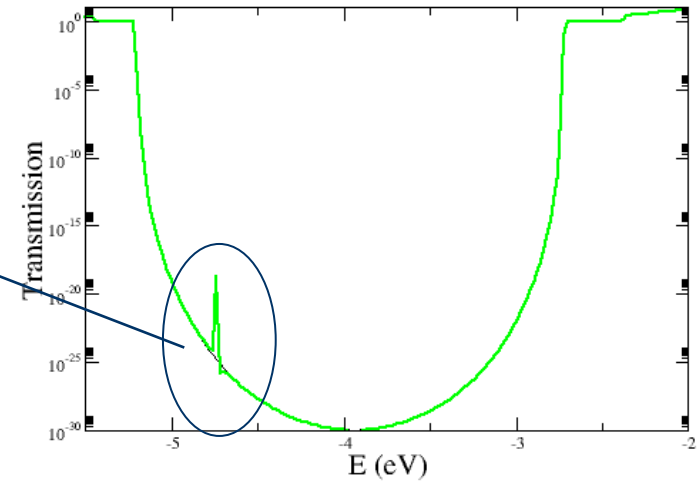
[110]SiNW H-passiv.



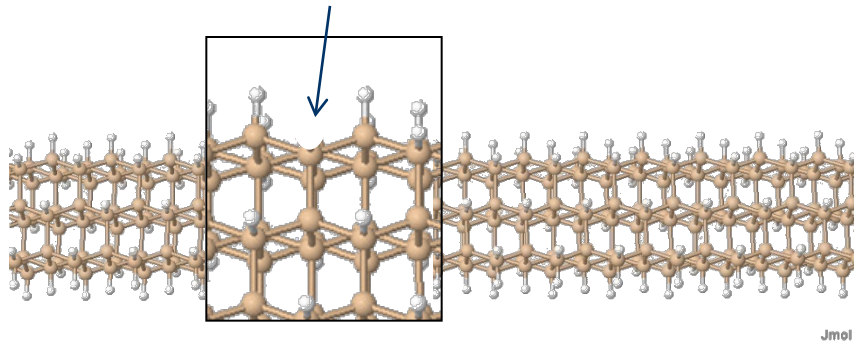
[110]SiNW



DB state



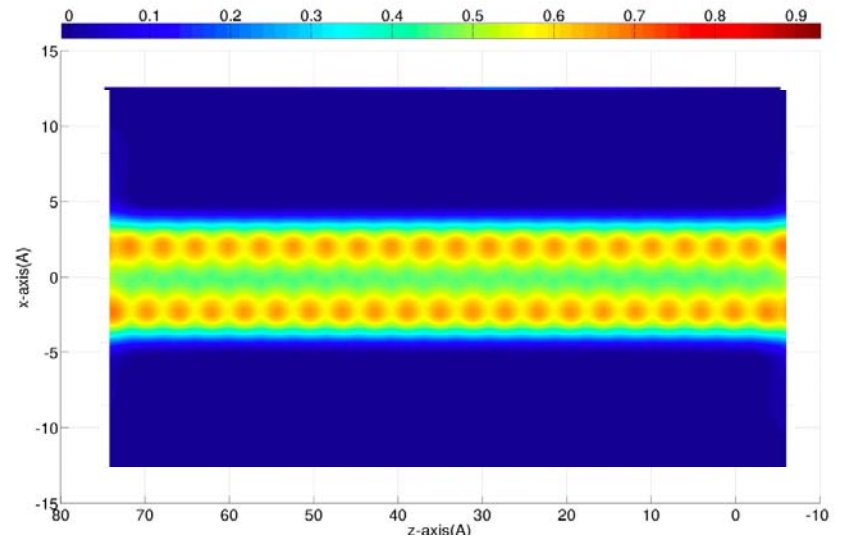
- Si dangling bond on p-doped SiNW (110)



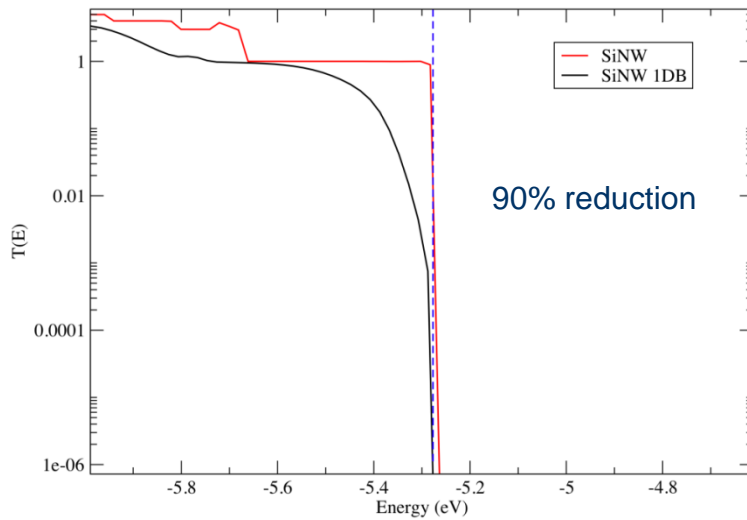
$$0.002 \text{ e/atom} \Leftrightarrow 9.3 \cdot 10^5 \text{ cm}^{-1}$$

$$\Leftrightarrow 10^{20} \text{ cm}^{-3}$$

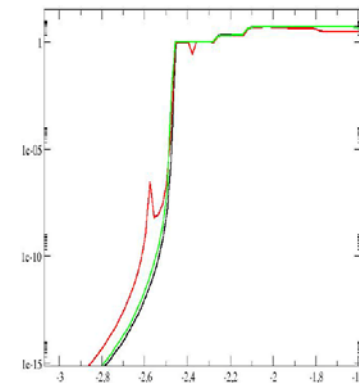
Potential (V)



Valence band



Conduction band

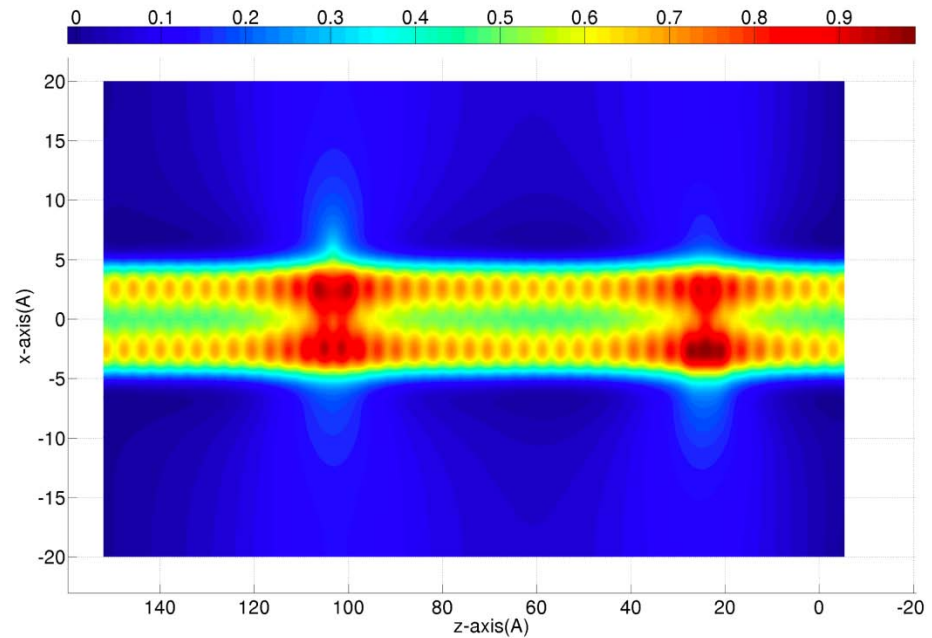
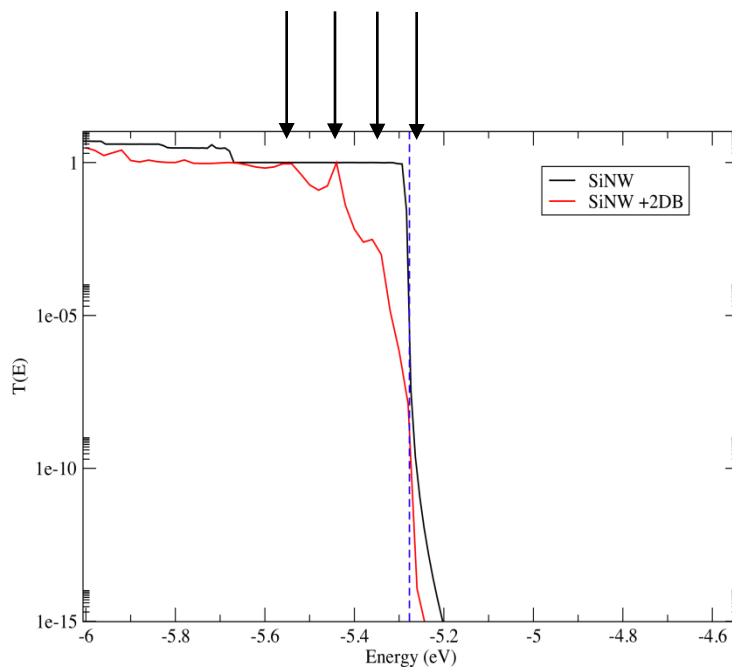


# Effects of two defects

2 DG bonds produce a further reduction

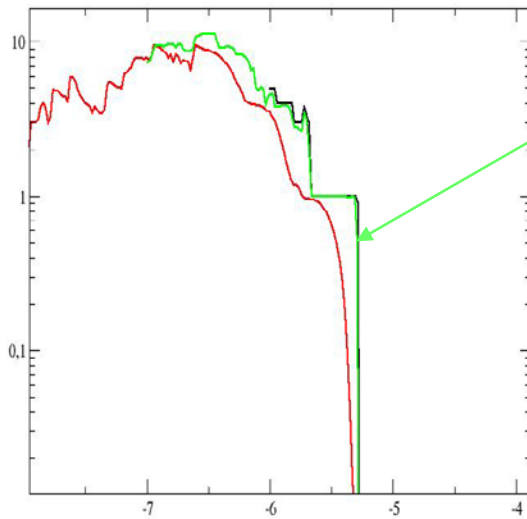
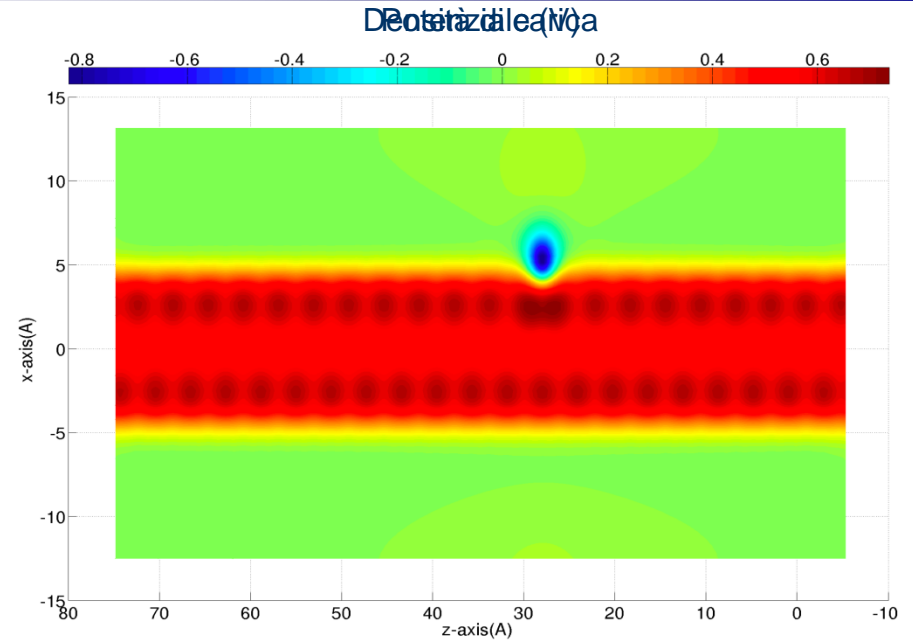
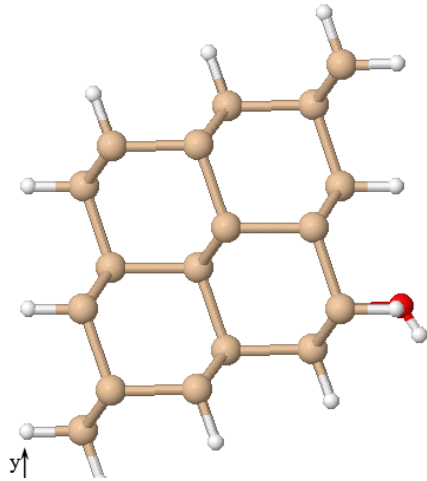
DG bonds are on 2 random sides

Interference peaks

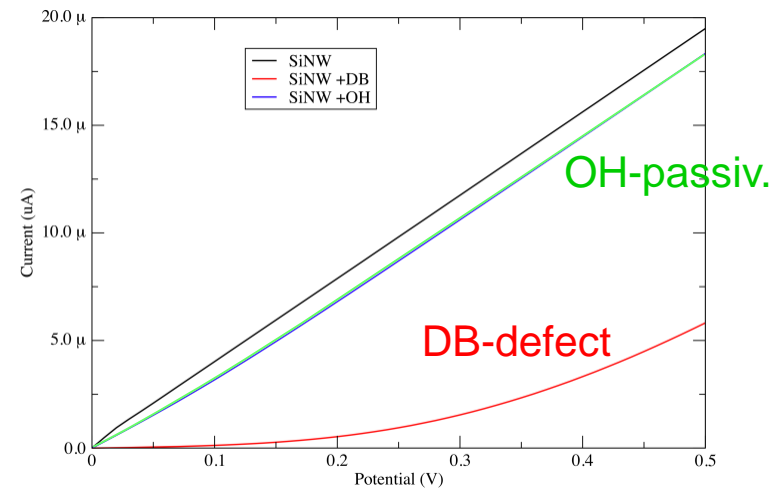


Nanowire	$G(E_f)$ [ $\Omega^{-1}$ ]	$\Delta\%$
SiNW Ideal (7.72 nm)	$5.04 \times 10^{-5}$	-
SiNW 1DB (7.72 nm)	$5.08 \times 10^{-6}$	90.69%
SiNW 2DB (15.22 nm)	$4.27 \times 10^{-6}$	91.53%

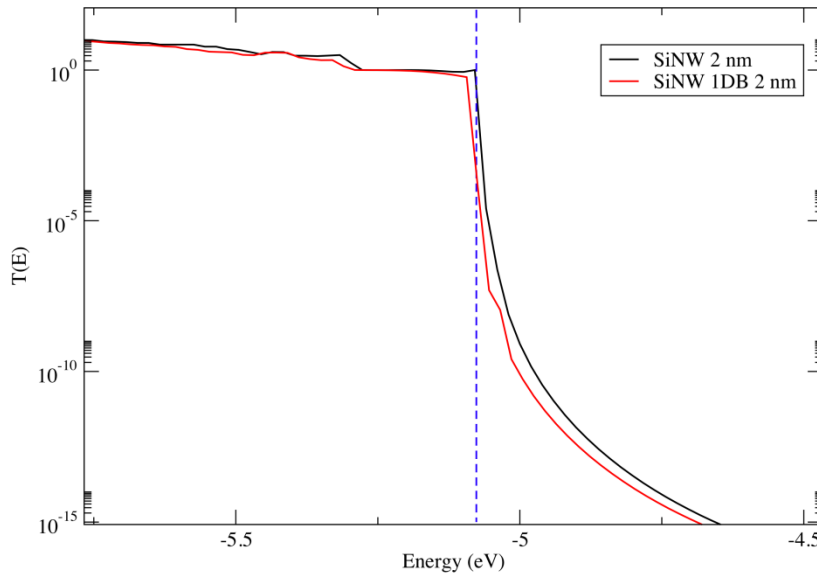
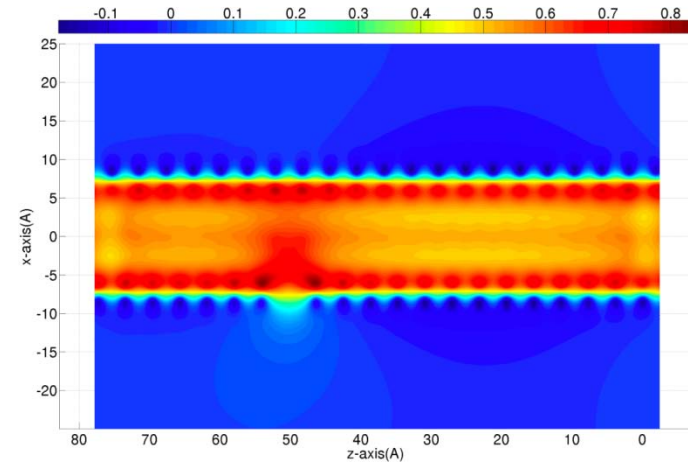
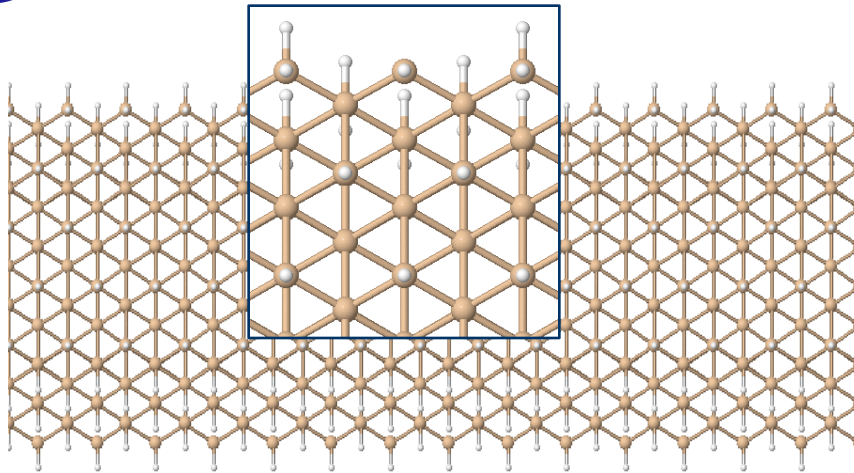
# OH passivated bond



OH passivated





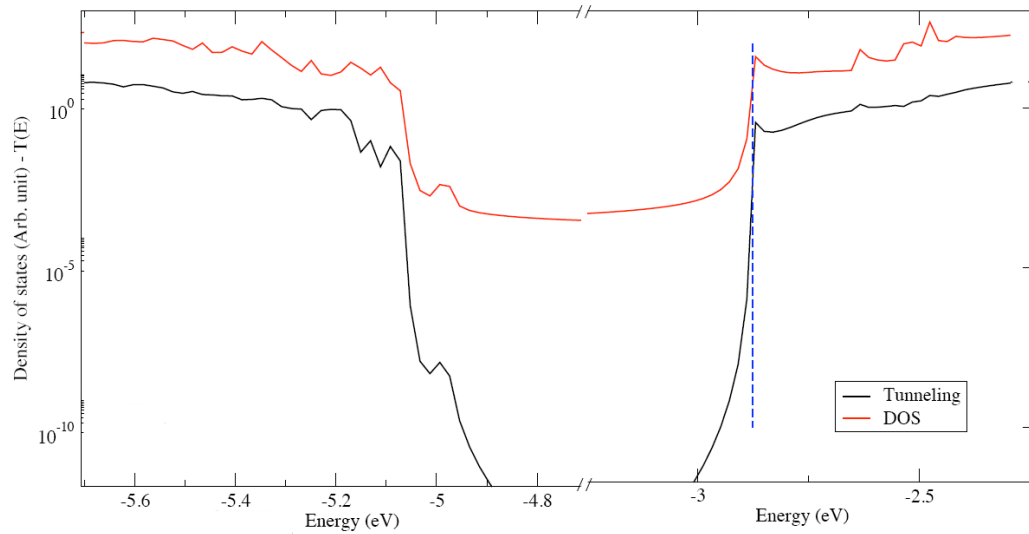
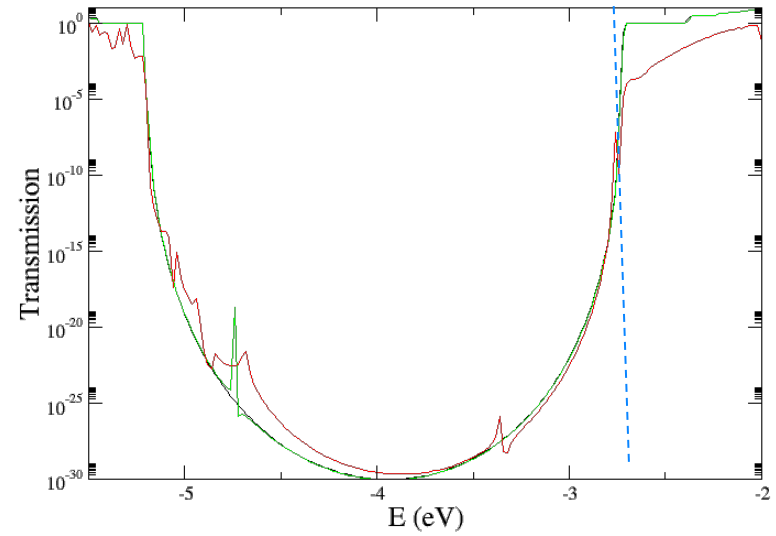
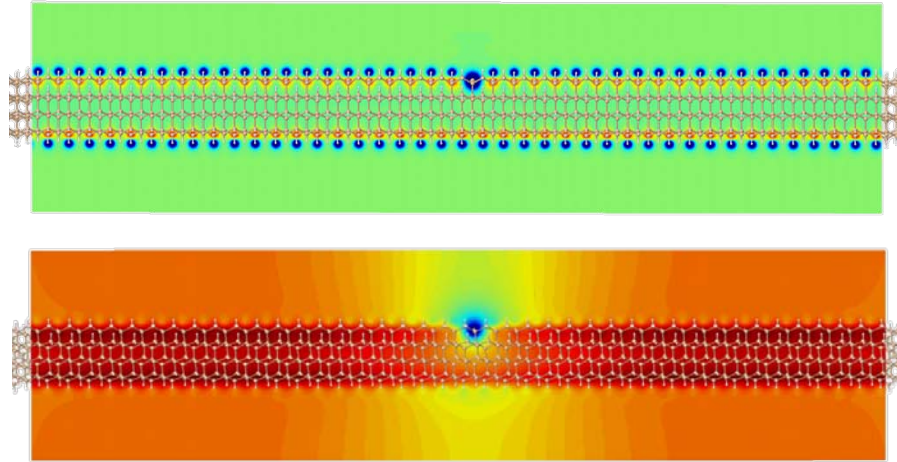


Less severe effect: 32% reduction

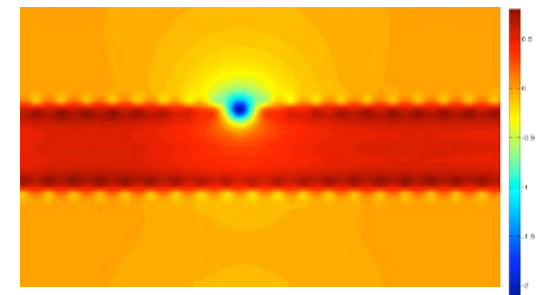
The DB defect is practically **neutral**

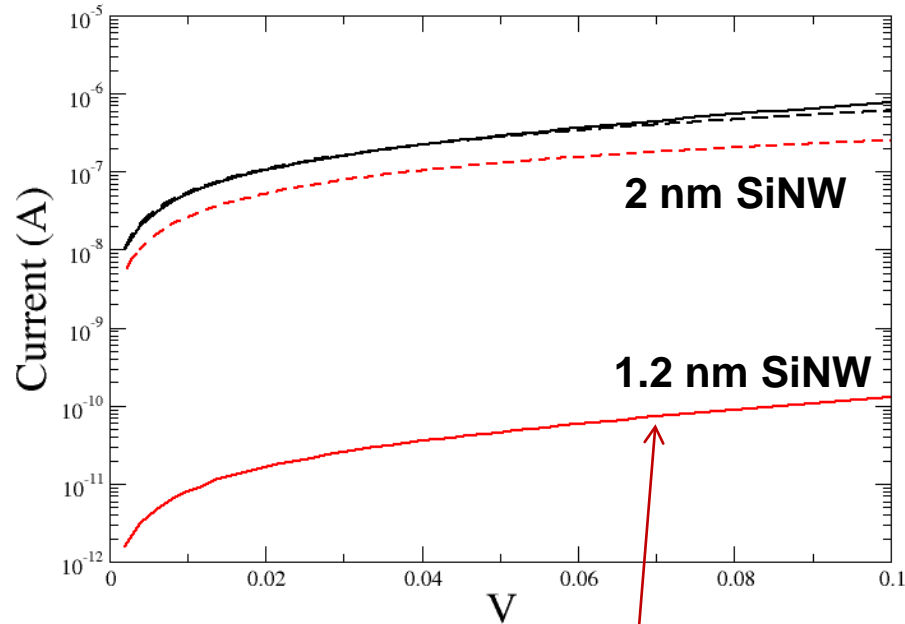


1.2 nm

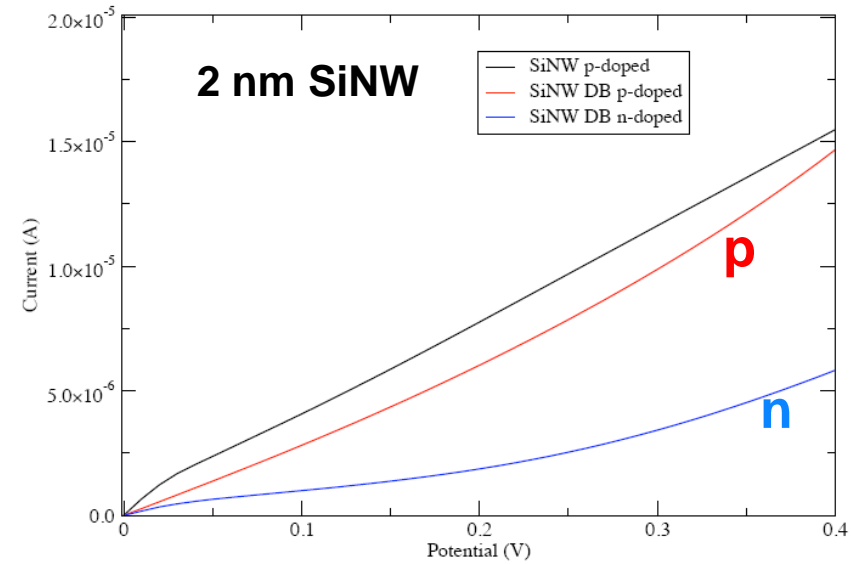


2 nm



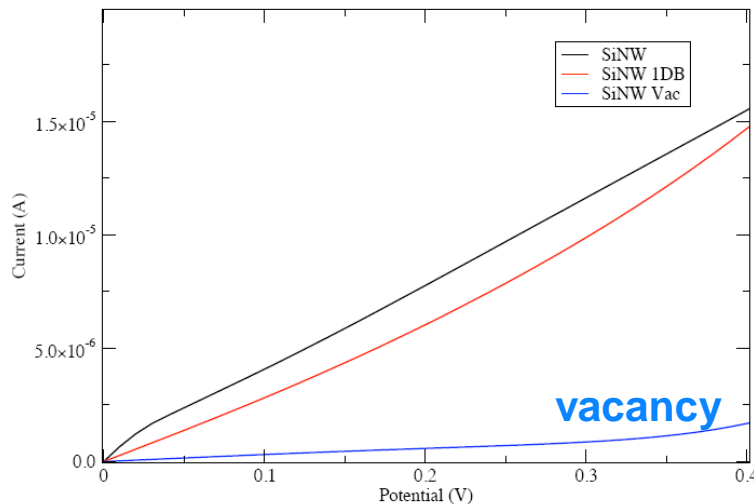
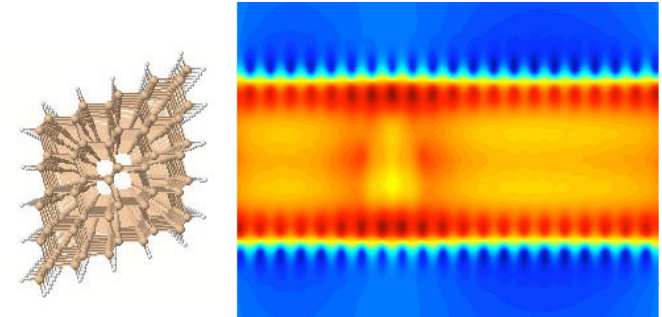
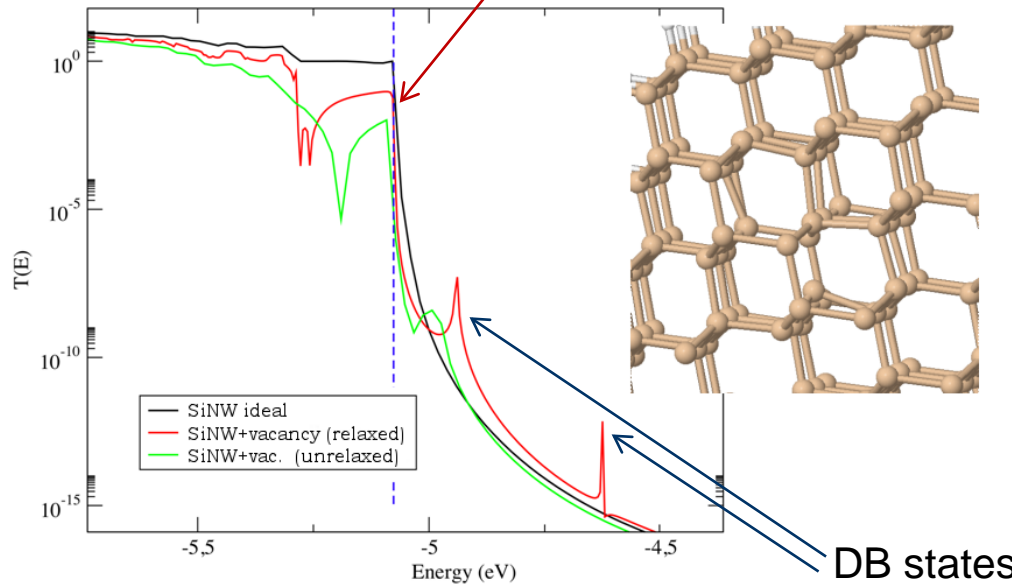


Severe reduction of current



Conductance can be severely affected in ultra-narrow n-doped SiNW  
The effect is much smaller on larger NW.

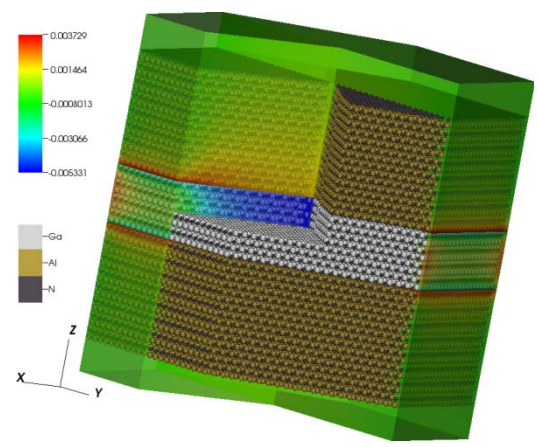
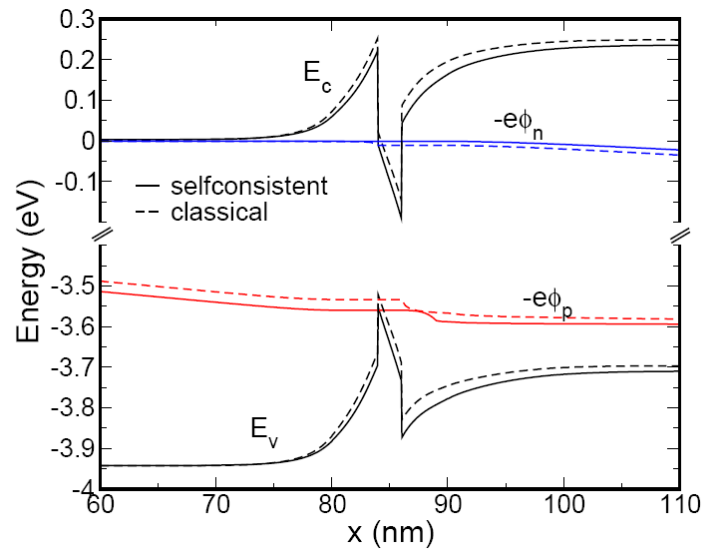
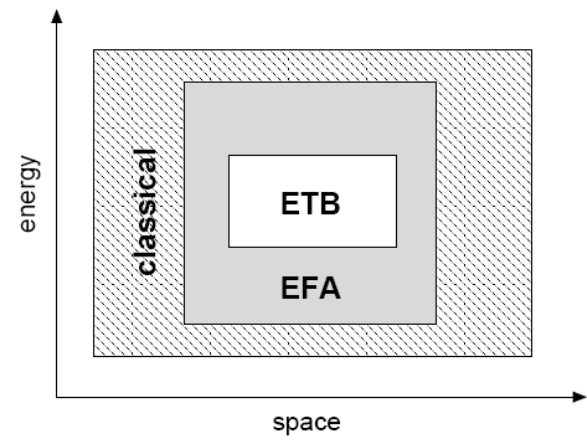
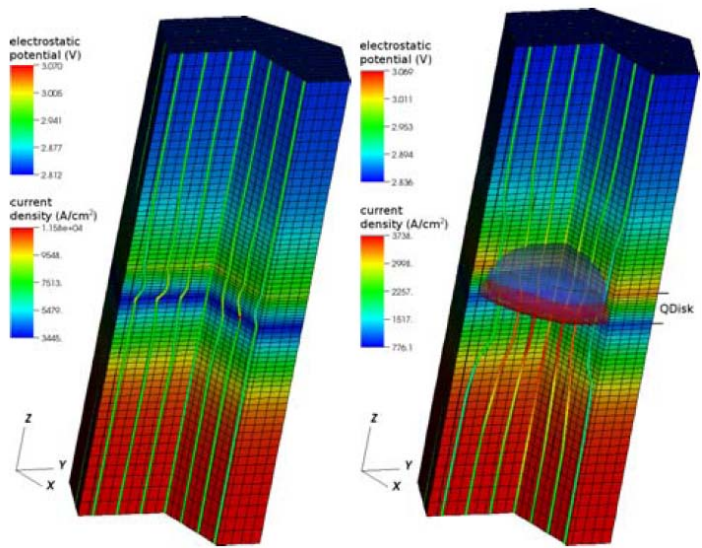
Relaxation decreases Si-Si distance, increasing tunneling



- A Si vacancy can have a large impact on p-doped NW.
- The effect is similar in magnitude to a DB in a n-doped NW.

- Negatively charged DB are possible in (110)SiNW
- These defects can significantly affect transport of ultra narrow wires
- The effect of DB defect is less important in p-doped (110)SiNW
- In both *p&n*-doped NWs the effect of Si-vacancies is non-negligible

<http://www.tibercad.org>



*sp<sup>3</sup>d<sup>5</sup>s\* Empirical TB*

**POSTER SESSION !!**



**Prof. Aldo Di Carlo**

**Gabirele Penazzi, PhD**

**Marco Pacini, Student**

**Luca Salvucci, Student**

**Matthias Auf Der Maur, Post Doc**

**Fabio Sacconi, Post Doc**

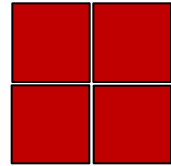
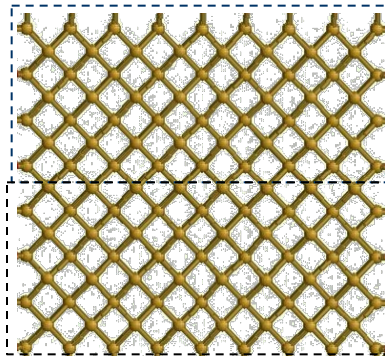
**Alessio Gagliardi, Post Doc**

**Dr. Bálint Aradi**

**Prof Th. Frauenheim @ BCCMS, Bremen**

**Thank you**

# Sub-partitioning of each layer

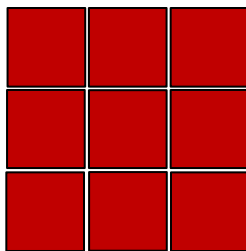


$$G_{11}(E) = (ES_{11} - H_{11} - H_{12}g_{22}H_{21})^{-1}$$

$$g_{22}(E) = (ES - H_{22})^{-1}$$

$G_{11}(E)$	$G_{12}(E) = -G_{11}H_{12}g_{22}$
$G_{21}(E) = -g_{22}H_{21}G_{11}$	$G_{22}(E) = g_{22} + g_{22}H_{21}G_{11}H_{12}g_{22}$

$$2 O(m^3)/8 + \text{MM mult} \approx O(m^3)/3$$



$$O(m^3)/9 + \text{MM mult} \approx O(m^3)/6$$

## LibNEGF

- General Sparse Matrices (CSR)
- Automatic partitioning (METIS)
- Parallel computations (MPI/OpenMP)
- GPU acceleration (?)

... work in progress...